ABSTRACT

This paper reports on a novel temperature-compensated single-crystal silicon resonator that has a quadratic temperature characteristic with a high turn-over temperature. An energy-trapped resonance mode is synthesized from acoustic coupling of evanescent and propagating phonons with opposite temperature sensitivity trends in a <100>-aligned engineered waveguide (phonon trap). A 77MHz device implemented in AlN-on-silicon platform shows a Q of 13,000 and a turn-over temperature of 87°C facilitating implementation of an oven-controlled frequency reference. An oscillator implemented using this device, while self-ovenized by a DC current passing through its body, exhibits a consistent phase-noise of -106 dBc/Hz at 1kHz offset from carrier.

INTRODUCTION

For the past decade, MEMS resonators have been promising realization of highly-stable frequency references as an integrated alternative to replace their Quartz-based discrete counterparts. Although MEMS oscillators have been successful in surpassing Quartz references in several performance metrics including phase-noise and long-term stability [1], however large temperature sensitivity of these devices has remained a big challenge, especially as MEMS oscillators are targeting TCXO and OCXO markets with sub-ppm and sub-ppb instability requirements respectively. To address this challenge, a large variety of device-level [2, 3] and circuit/system-level [4] temperature compensation techniques have been proposed. However, these techniques usually impose large deviation from resonator design and implementation baseline, including excessive power consumption or manufacturing complexities.

In this paper we leverage single-crystal silicon as a designable and controllable thermo-mechanical platform to realize flexible, yet accurate, control on the temperature characteristic of the resonator frequency. Evanescent phonons with highly-positive temperature coefficient of frequency (TCF) are acoustically coupled to propagating phonons with negative TCF to create a temperature-stable resonance mode in a geometrically-engineered acoustic waveguide. Proper distribution of acoustic energy in propagating and evanescent fields in such structure not only provides compensation of the linear TCF, but also substantially eliminates support-loss through trapping propagating phonons in the central region of the acoustic cavity and far from anchoring regions (hence the name phonon trap). This, in turn, obviates the need for narrow tethers to anchor the device to the substrate and facilitates self-ovenization of the device by passing a DC current uniformly distributed across the cross-section of the cavity.

TEMPERATURE-COMPENSATED PHONON TRAP

Proper cascading and geometry engineering of multiple waveguides complying with displacement and strain continuity conditions at transition boundaries facilitate realization of synthesized modes in a phonon trap [5]. While a central waveguide supports propagating phonons, waveguides in flank regions can only support evanescent phonons with exponentially decaying energy as moving towards the substrate. Figure 1 demonstrates the concept of phonon trap through dispersion characteristics of guided waves in rectangular waveguides. The synthesized mode is highlighted with stars on different branches.

Since the device is engineered to exclusively trap the energy of a single phonon-type, various spurious modes which are commonly excited in piezoelectrically-transduced resonators are efficiently suppressed as their energy leaks to the substrate through wide anchors of the structure. Figure 2 shows the TCF behavior of different phonon branches of a single waveguide, exhibiting highly different characteristics for different phonon types, as well as opposite trends in evanescent and propagating portions of each branch.

DEVICE CHARACTERIZATION AND DISCUSSION

Figure 3 shows the SEM image of the <100>-aligned phonon trap implemented on the same chip with two conventional silicon bulk acoustic resonators (SiBAR) aligned to <100> and <110> directions to highlight the efficiency of temperature compensation by comparing their temperature behavior.
**SELF-OVENIZED MEMS OSCILLATOR**

An oven-controlled MEMS oscillator is implemented using the 77MHZ phonon trap. Figure 6 shows the frequency behavior of the oscillator for different self-ovenizing DC currents passing through the device body.

![Figure 6: Frequency behavior of oscillator for different self-ovenizing DC currents.](image)

Figure 6: Frequency behavior of oscillator for different self-ovenizing DC currents. Ovenization currents can be significantly reduced by proper die layout and vacuum-encapsulation.

A consistent phase-noise of -106 dBC/Hz at 1kHz offset from carrier has been measured from the oscillator for different ovenization currents, including the current required to have the device operating at turn-over point in room-temperature (Figure 7). Such performance demonstrates the potential of the device for realization of highly-stable oven-controlled MEMS oscillators.

![Figure 7: Phase-noise performance of the oscillator for different ovenization DC currents.](image)

Figure 7: Phase-noise performance of the oscillator for different ovenization DC currents passing through the device body.

**REFERENCES**


**ACKNOWLEDGEMENT**

This work was supported by Integrated Device Technology (IDT), and in part by DARPA TIMU program through SSC pacific contract # N66001-11-C-4176.

**CONTACT**

*R. Tabrizian, tel: +1-404-259-7322; roozbeh@gatech.edu*